Dissertation

Removal of Polymer Coating with Supercritical Carbon Dioxide

Submitted by

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Abstract of Dissertation

Removal of Polymer Coatings with Supercritical Carbon Dioxide

This work investigates the use of supercritical fluids, and carbon dioxide in particular, for the removal of polymer coatings. Research into new supercritical fluid applications is nearly always based on a trial and error approach, and frequently requires evaluating each operation on a case-by-case basis. A significant improvement in this approach is accomplished with the development of a framework in which polymer-CO₂ interactions can be evaluated and the number of experimental trials reduced.

The basic model developed is built upon the three-component solubility parameter (HSP) concept, which is widely used in the coatings industry to aid in the selection of solvents. Temperature and pressure dependent HSP values have been develop for supercritical CO₂, using a methodology extendable to other supercritical fluids. Equations were also developed to calculate HSP's for cosolvents and polymers. With the solvent, cosolvent, and polymer thus fully characterized in terms of the HSP values, the systems are then analyzed in terms of the like and unlike (solvent/polymer, cosolvent/polymer, and solvent/cosolvent) binary pairs. In addition to this study, consideration of specific interactions, such as Lewis acid/base interactions between the solvent and polymer or between the cosolvent and polymer are examined for their role in determining a favorable (polymer coating removal) result.

The model was tested on two real-world applications: involving poly(methyl

methacrylate) (PMMA) and polycarbonate (PC) coatings. Several organic liquids were

evaluated as cosolvents, including at least one example of a non-polar fluid, a Lewis acid,

and a Lewis base. Results of this study found the following interactions, listed in order of

importance in the removal of polymer coatings, to be (1) specific interactions between the

solvent and polymer, in the case of PMMA and CO2, or specific interactions between the

cosolvent and polymer, in the case of PC and CO2, (2) weaken polymer/polymer

interactions as a result of polymer swelling and subsequent lowering of the polymer HSP

values, (3) specific interactions between the solvent and cosolvent are not necessary and

in the case of specific interactions between the cosolvent and polymer, may be

undesirable.

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"I hear and I forget, I see	e and I remember, I do an	nd I understand."
		Confucius
To Jim Rubin, for taki	ing the trip with me and n	naking the journey worthwhile

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List of Symbols

- T Temperature
- T_C Critical temperature
- T_r Reduced temperature, T_c
- T_{br} Reduced boiling temperature, T_b / T_c
- T_g Glass transition temperature
- P Pressure
- P_C Critical pressure
- P_r Reduced pressure, P_c
- V Volume
- **r** Density
- \mathbf{r}_{r} Reduced density, $\frac{\rho}{\rho_{c}}$
- α^p Polarizability
- **m** Dipole moment
- I Ionization potential
- **s** Collision diameter
- *r* Distance between molecules
- r_O Equilibrium distance between molecules
- Q Quadrupole moment
- U Total energy of a system
- $_{1}Q_{2}$ Heat transferred to a system
- $_{1}W_{2}$ Work transferred to a system
- E Internal energy
- n Ratio, (Internal Pressure/Cohesive energy density)
- S Entropy

Н Enthalpy GGibbs free energy d Total solubility parameter d₁ Solubility parameter – nonpolar component d_t Solubility parameter – polar component d_d Solubility parameter – dispersion component $d_{\mathcal{D}}$ Solubility parameter – polar component d_h Solubility parameter – hydrogen bonding component x Mole fraction F Volume fraction R_{o} Interaction radius R_a Distance (expressed as a radius) between two different HSP points R_o^{liq} Interaction radius based on polymer dissolution behavior in liquid solvents R_{o}^{SCF} Interaction radius based on polymer behavior in SCF Index of refraction n_{D} 3 Dielectric constant a Thermal expansion coefficient h Isothermal compressibility Saturation vapor pressure p_s B(T) Tait parameters B_{0} Material dependent parameter B_1 Material dependent parameter Material dependent parameter A_0 A_1 Material dependent parameter A_2 Material dependent parameter Surface tension γ P_{S} Parachor parameter

 $k_{\rm D}$

Henry's law constant